



Product Change Notification

Change Notification #: 117507 - 00
Change Title: Select Intel® Optane™ Memory M10 Series, PCN 117507-00, Documentation, Brexit Warranty Booklet Change
Date of Publication: March 24, 2020

Key Characteristics of the Change:

Documentation

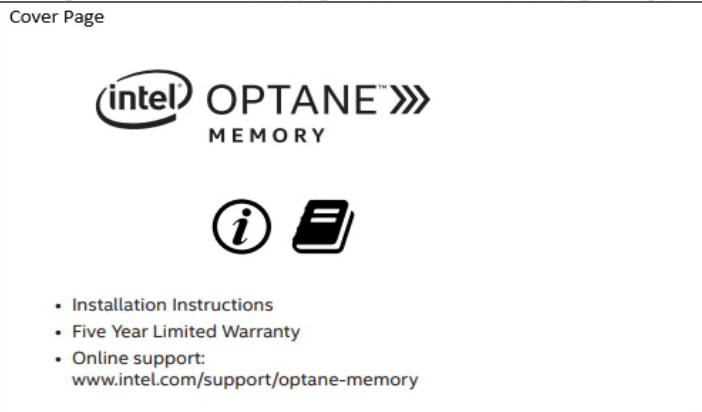
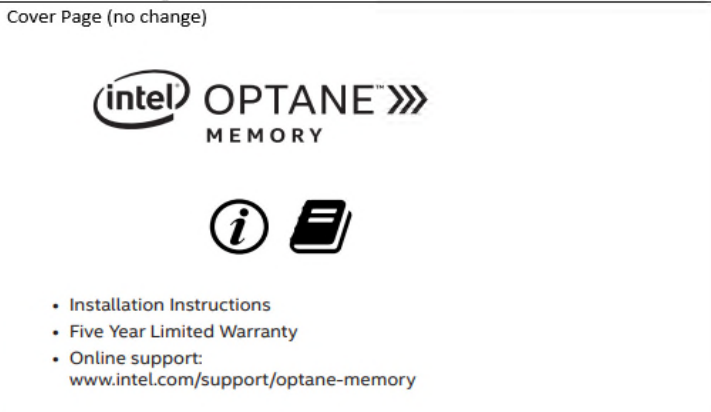
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	April 8, 2020
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Description of Change to the Customer:

The Intel® Optane™ Memory M10 Series products listed in the Products Affected table will undergo the following change:

The warranty booklet will be changed for Brexit.

Existing booklet J54604-002 (only page 2 and the IPN on the last page change)	New booklet changes J54604-003
Cover Page 	Cover Page (no change) 

Intel Corporation
2200 Mission College Blvd
Santa Clara, CA 95054-1549 USA

EU Single Point of Contact:
Intel Corporation (UK) Ltd.
Attn: Corp. Quality
Pipers Way, Swindon, Wiltshire SN3 1RJ UK



In the EU, this symbol means that this product must not be disposed of with household waste. It is your responsibility to bring it to a designated collection point for the recycling of waste electrical and electronic equipment. For more information, please contact your local waste collection center or your point of purchase.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709A requirements, and the PCB/Substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

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Intel Corporation
2200 Mission College Blvd
Santa Clara, CA 95054-1549 USA

EU Single Point of Contact:
Intel Deutschland GmbH
Attn: Corp. Quality
Am Campeon 10-12, 85579 Neubiberg, Germany



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Customer Impact of Change and Recommended Action:

There is no change to the form, fit, function, quality or reliability of the product. This change affects the warranty booklet

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® Optane™ Memory M10 Series (16GB, M.2 80mm PCIe 3.0, 20nm, 3D XPoint™) Retail Box 10 Pack	MEMPEK1J016GAXT	962391
Intel® Optane™ Memory M10 Series (32GB, M.2 80mm PCIe 3.0, 20nm, 3D XPoint™) Retail Box 10 Pack	MEMPEK1J032GAXT	962392
Intel® Optane™ Memory M10 Series (64GB, M.2 80mm PCIe 3.0, 20nm, 3D XPoint™) Retail Box 10 Pack	MEMPEK1J064GAXT	962393

PCN Revision History:

Date of Revision:
March 24, 2020

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

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